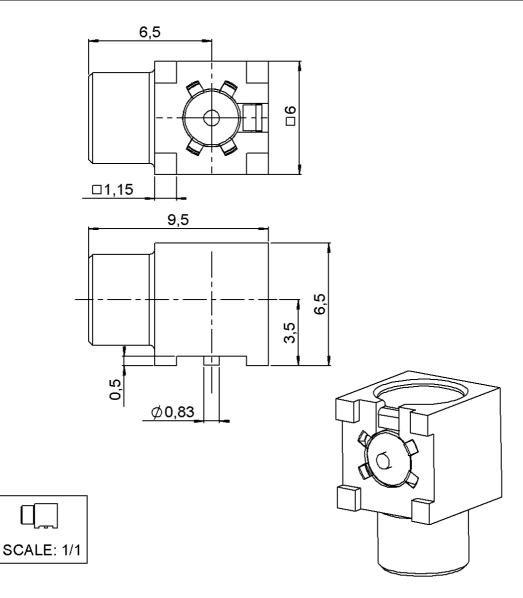
# RIGHT ANGLE FEMALE RECEPTACLE FOR PCB SOLDER LEGS

R213.664.800

Series: MCX 75



All dimensions are in mm.

 COMPONENTS	MATERIALS	PLATINGS (μm)
BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS -	BRASS BERYLLIUM COPPER - PTFE - BRASS -	.GOLD 0.2 OVER NICKEL 2 GOLD 0.5 OVER NICKEL 2GOLD 0.2 OVER NICKEL 2 -

**Issue:** 0740 C



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#### **PACKAGING**

## Standard Unit Other 100 'W' option Contact us

#### **SPECIFICATION**

#### **ELECTRICAL CHARACTERISTICS**

 $\begin{array}{ccc} \text{Impedance} & \textbf{75} & \Omega \\ \text{Frequency} & \textbf{0-6} & \text{GHz} \end{array}$ 

VSWR 1.45 + 0,0000 x F(GHz) Maxi

Insertion loss

O.1  $\sqrt{F(GHz)}$  Maxi

RF leakage

O.2  $\sqrt{F(GHz)}$  dB Maxi

RF leakage

O.3  $\sqrt{F(GHz)}$  dB Maxi

Voltage rating335Veff MaxiDielectric withstanding voltage1000Veff miniInsulation resistance1000M $\Omega$  mini

#### **ENVIRONMENTAL**

Operating temperature -55/+155 ° C

Hermetic seal NA Atm.cm3/s

Panel leakage NA

#### **OTHERS CHARACTERISTICS**

Assembly instruction

Others:

#### **MECHANICAL CHARACTERISTICS**

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

10 N mini
NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 500 Cycles mini

Weight **1,6600** g

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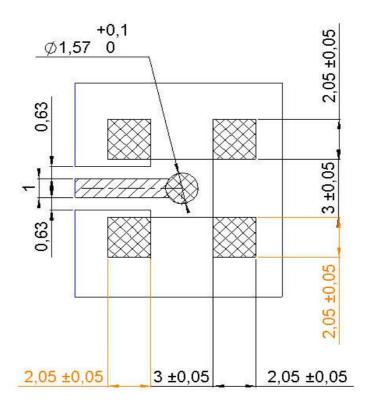
SOLDER LEGS Seri

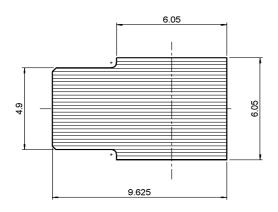
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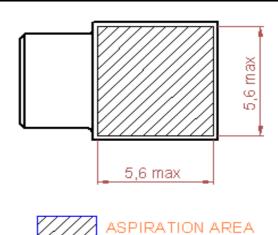
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#### MCX 75 SERIES - INFORMATION

Coplanar line : pattern and signal are on the same side . Thickness of PCB :.063(1.6mm) The material of PCB is the epoxy resin of glass fabrics bacs . (Er = 4.8) . The solder resist should be printed exept for the land pattern on the PCB .







SHADOW OF MCX RECEPTACLE FOR VIDEO CAMERA

ASPIRATION AREA

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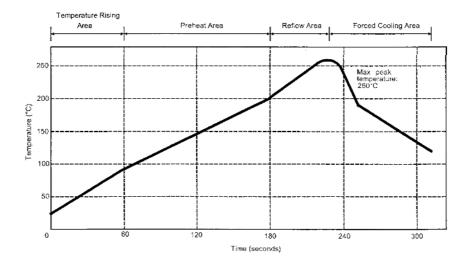
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## SOLDER PROCEDURE

- 1. Deposit solder paste 'SnAg4Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
  - We advise a thickness of 150 micromm (5.850 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. A video camera is recommended for positioning of the component. Adhesive agents must not be used on the receptacle.
- 3. This process of soldering has been tested with convection oven .Below please find ,the typical profile to use.
- 4. The cleaning of printed circuit boards is not obliged .
- 5. Verification of solder joints and position of the component by visual inspection.

**NOTE**: The receptacle and the plug must not be mated before completion of this procedure

#### **TEMPERATURE PROFILE**



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

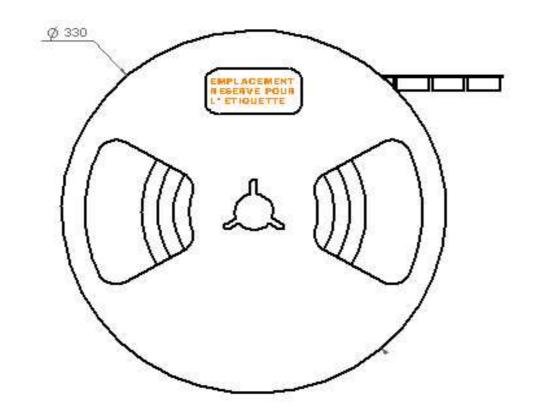
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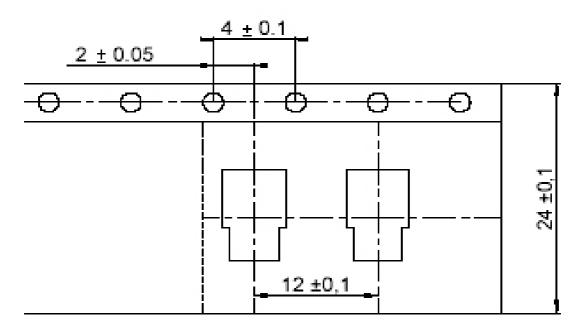


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